



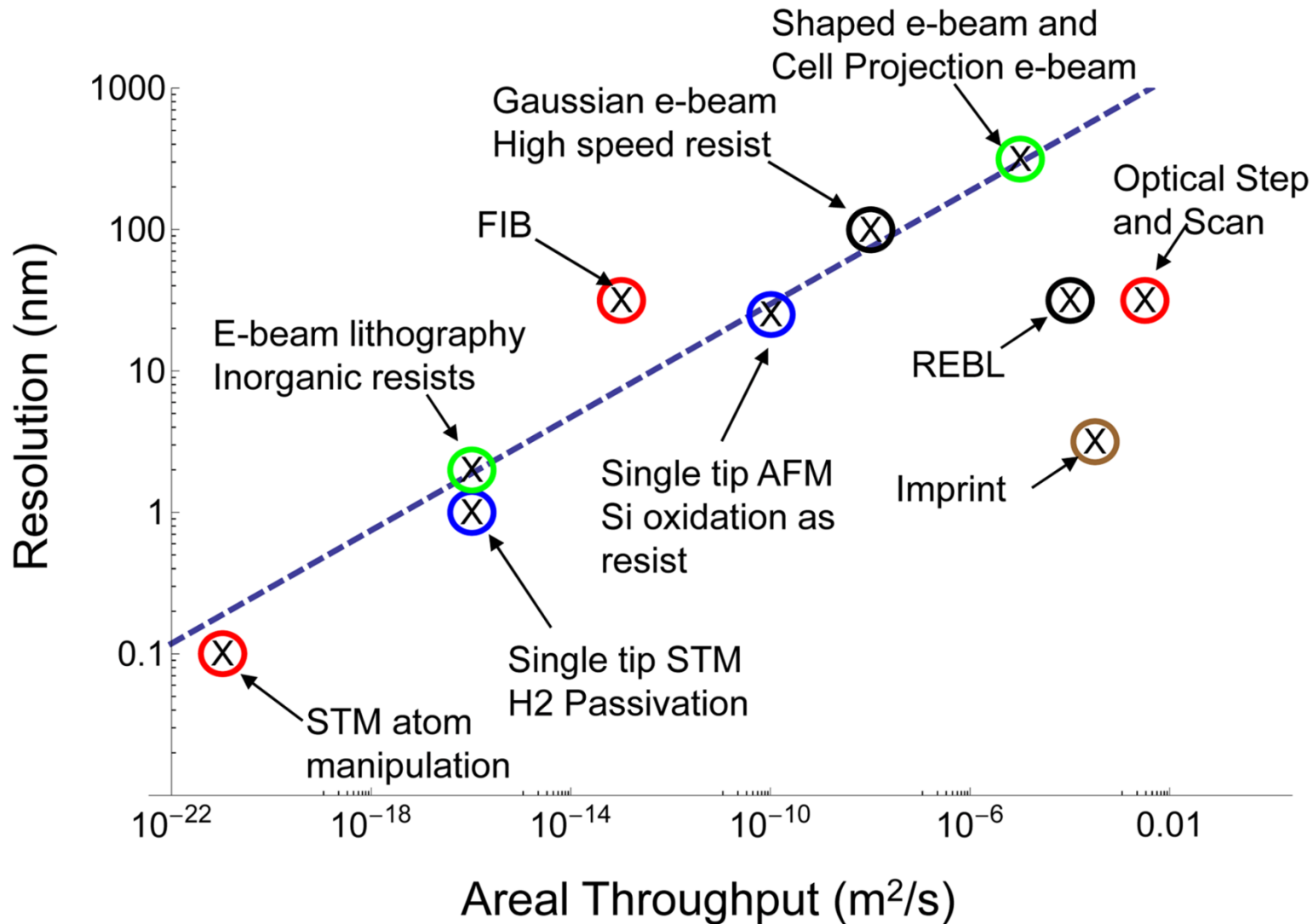
# Nanomanufacturing – Beyond Silicon

J. Alexander Liddle



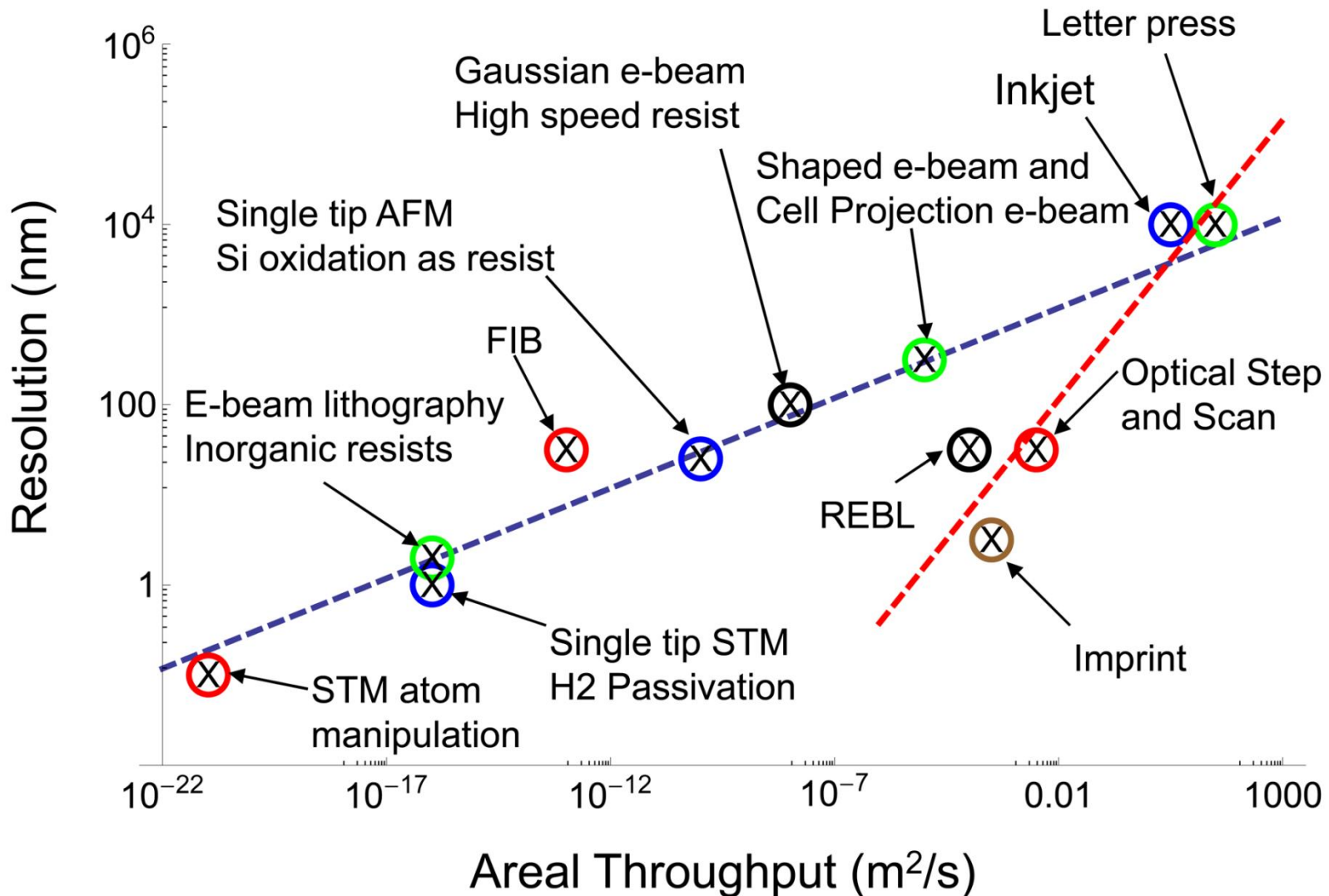
*NSF-NNI Nanosystems Workshop, March 2<sup>nd</sup> – 3<sup>rd</sup>, 2011*

# Nanofabrication & Nanomanufacturing Today



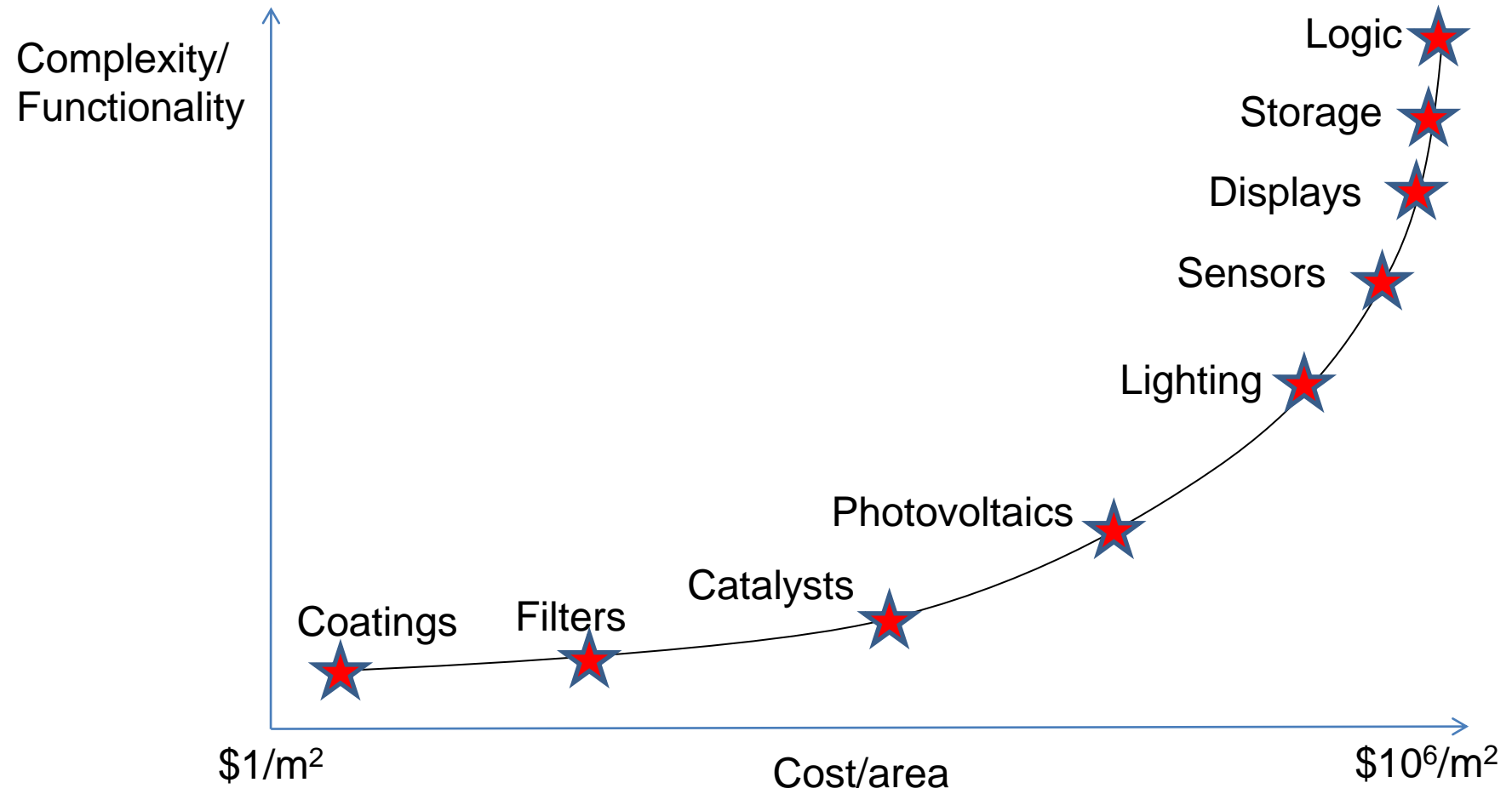
Liddle & Gallatin, *Nanoscale* – In press

# Nanofabrication & Nanomanufacturing Today

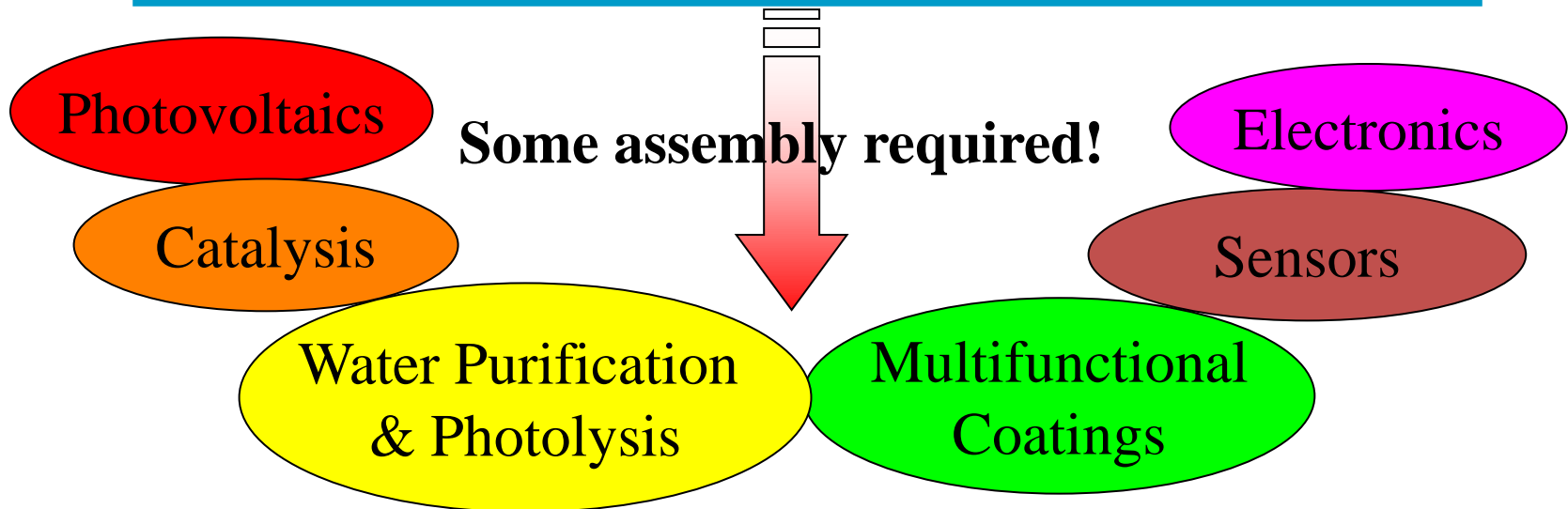
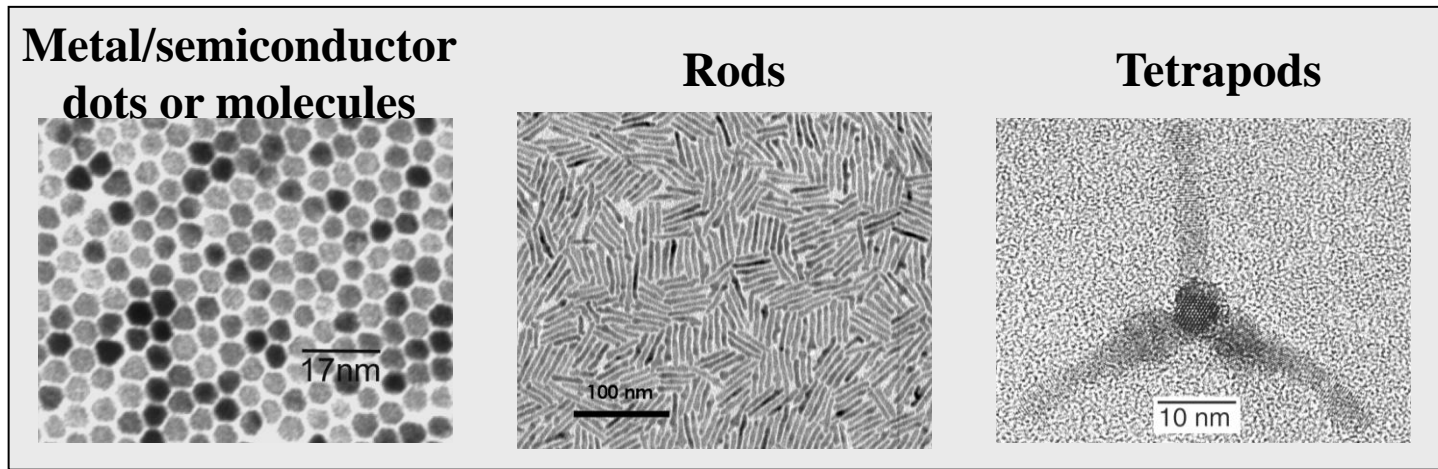


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# The Cost of Complexity

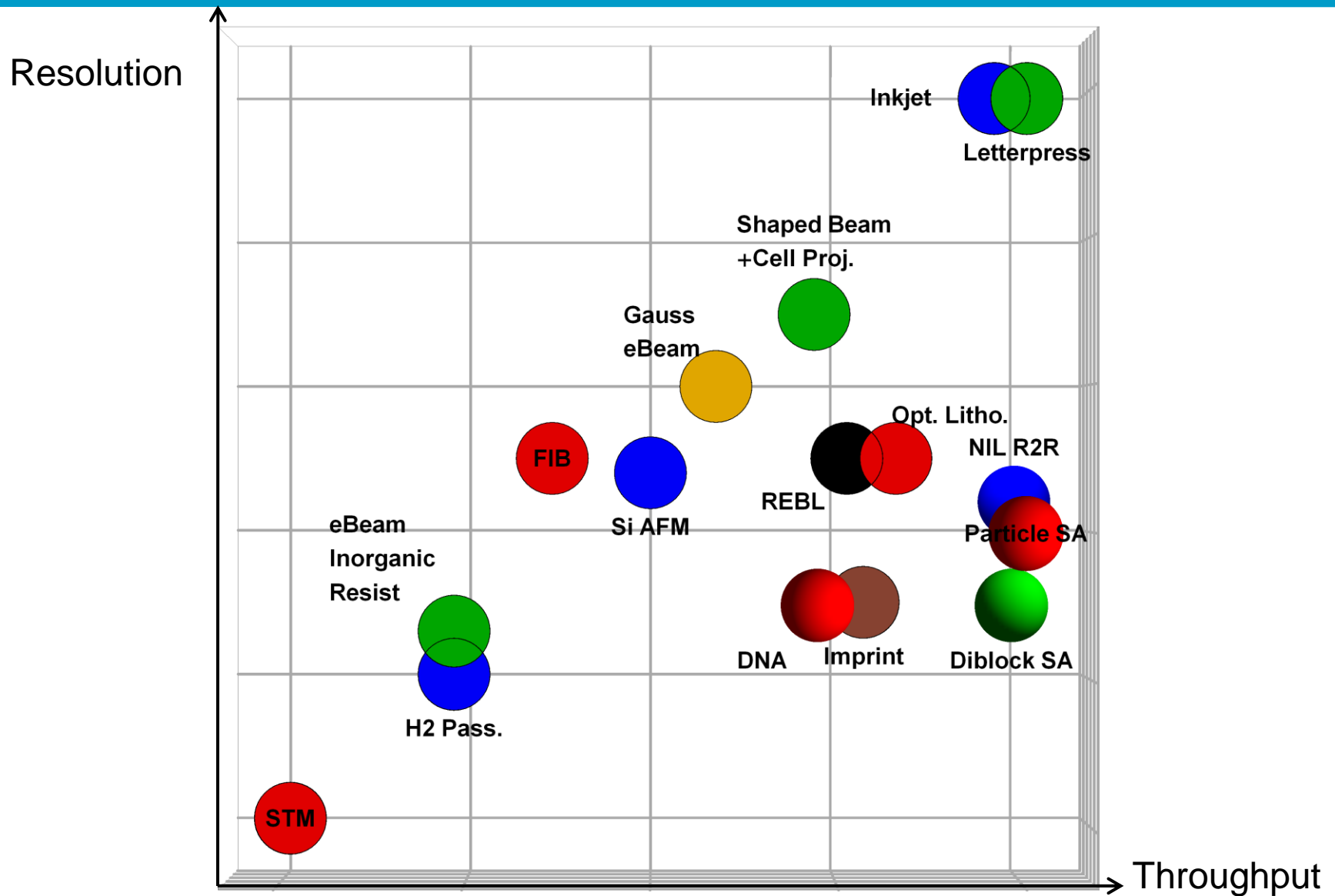


# Some Assembly Required

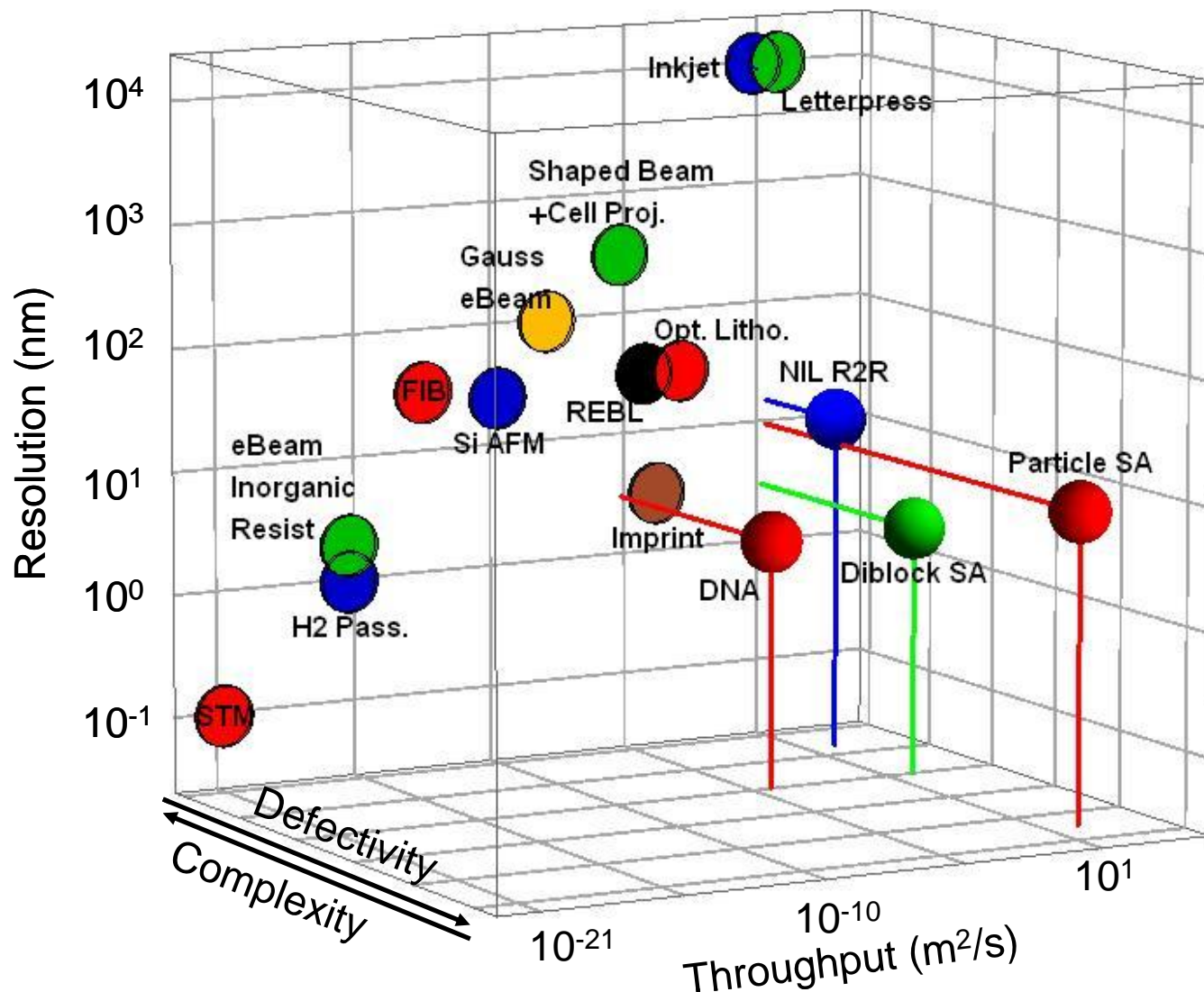




# Emerging Nanomanufacturing Methods



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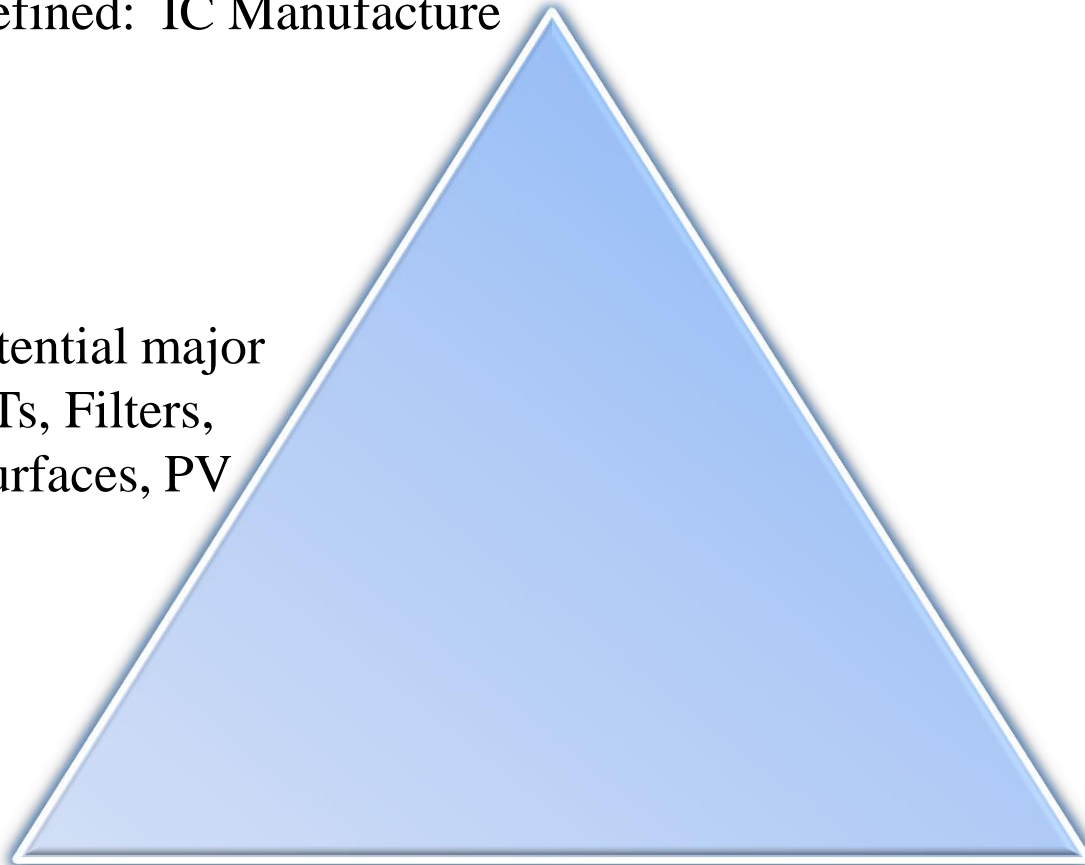
Liddle & Gallatin, *Nanoscale* – In press

# Nanomanufacturing Characteristics

Specific, well-defined: IC Manufacture

Developing, potential major industries: CNTs, Filters, Self-cleaning surfaces, PV

Broad, generic issues: Nanoparticle Manufacture & Assembly



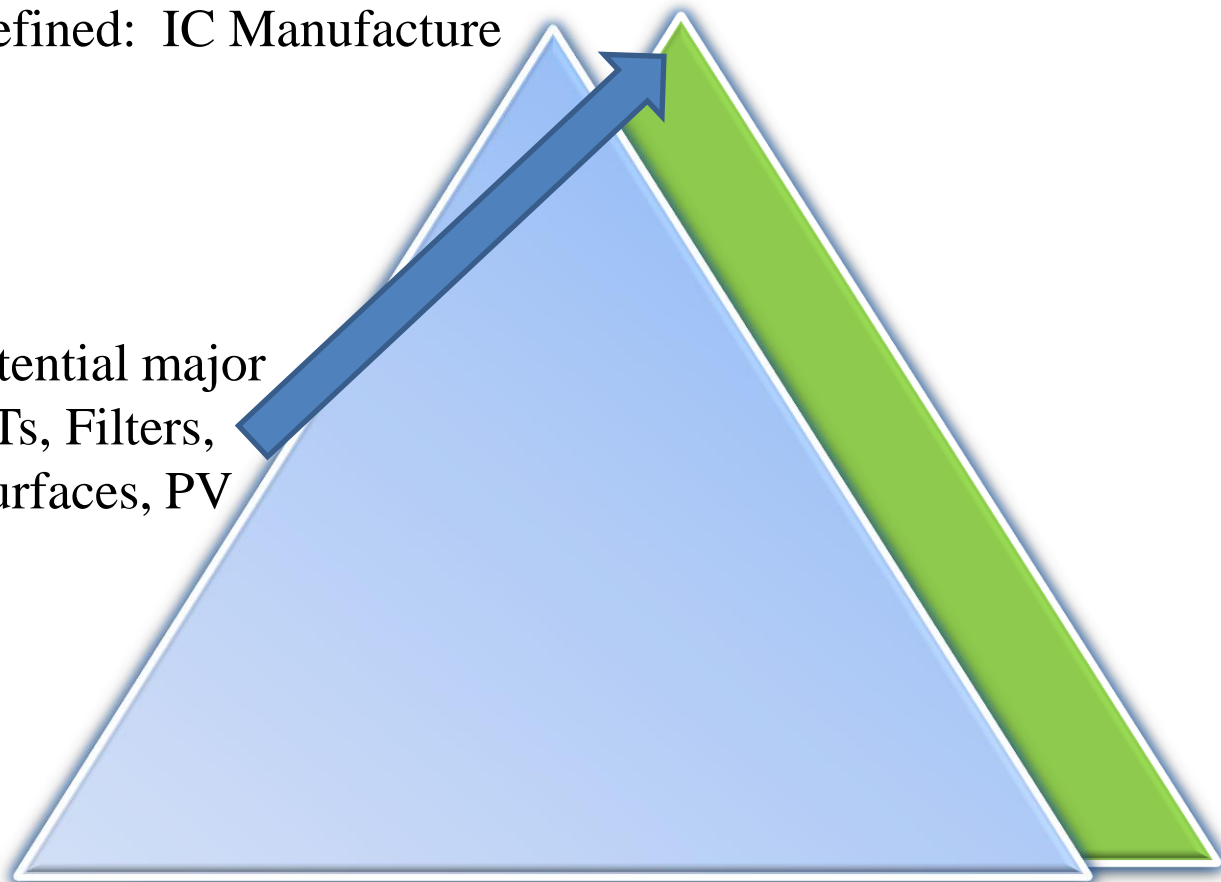


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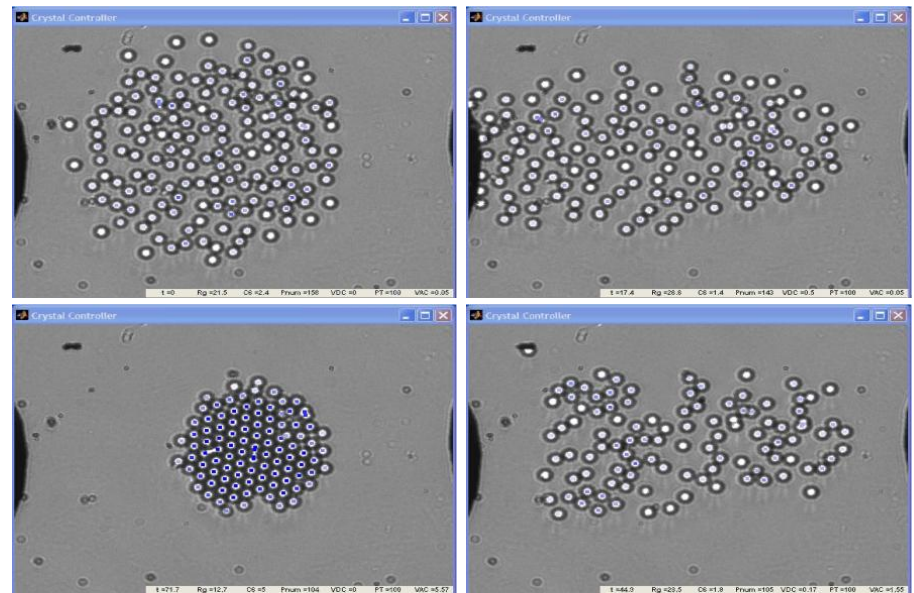
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# Control

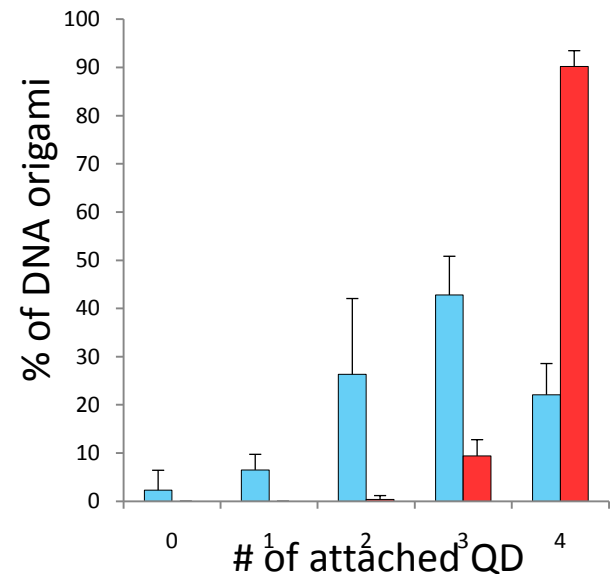
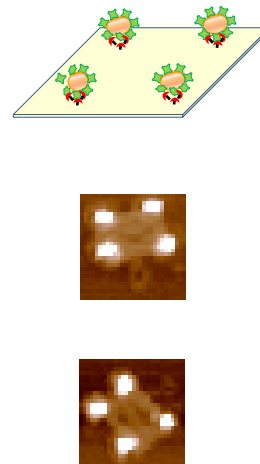
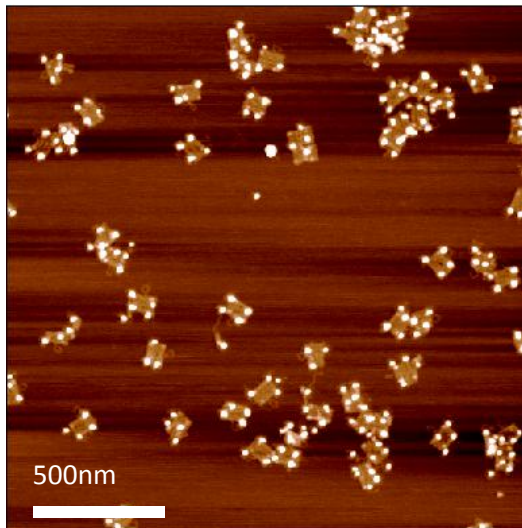
- Nanosystem fabrication involves assembly of  $10^9$  components
  - Top-down – reliable, slow, expensive
  - Bottom-up – fast, cheap & out of control
    - How do we bring such processes under control when we can't see or touch the individual pieces
  - Need to develop stochastic control methods
    - Control boundary conditions
      - Energy landscapes
    - Meaningful feedback parameters

Controlled formation of colloidal crystals using video microscopy and combined multiple actuation methods  
Juarez, Mathai, Bevan, Liddle, *in preparation*



# Standard Interfaces

- Standard interfaces enable modular design
  - Performance is sacrificed
  - Manufacturability, reliability and design turnaround speed are gained
    - How do we do this for nanosystems?



Assembly based on DNA origami – factors controlling speed & yield  
Ko, Gallatin, Liddle, submitted

# Diblock Copolymer Line-Edge Roughness by Resonant X-ray Scattering

## Objective

- Develop methods to measure the intrinsic line-edge roughness in self-assembled diblock copolymers to quantify their behavior in lithographic applications

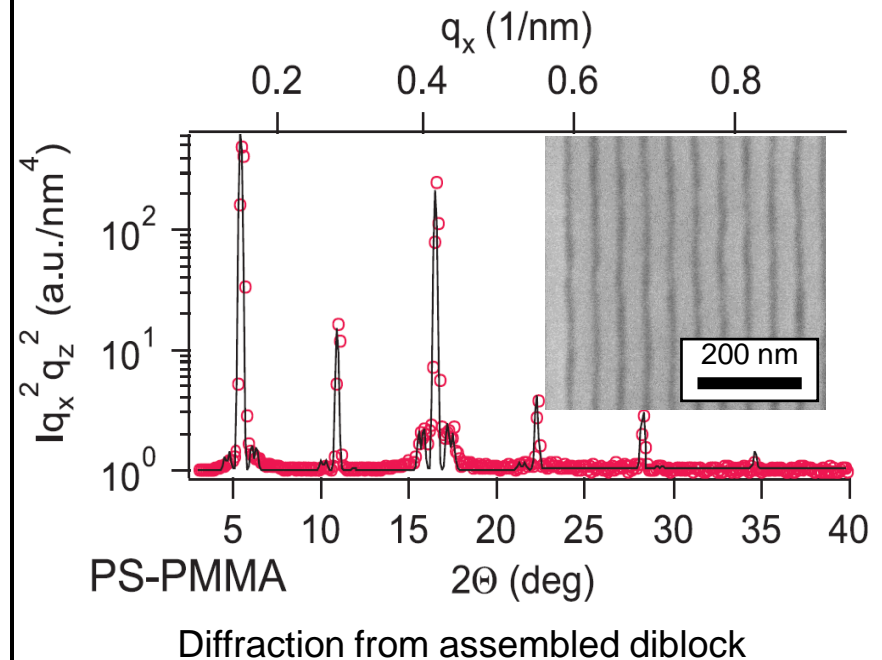
## Results and Impact

- Detailed measurements of diblock morphology from 50 nm thick films in transmission
- Patterned nanostructure produces high quality diffraction pattern enabling detailed parameter extraction
- “Scattering from pattern” concept applicable to many different nanotechnology problems

G. Stein, J. A. Liddle, A. Aquila, E. M. Gullikson, *Macromolecules*, **43** 433 (2010)

## Method

- Use directed self-assembly of diblock on nanolithographic template on SiN membrane to create effective diffraction grating
- Use x-ray energy tuned to specific chemical bond to achieve high contrast between phases



# Real Time Roll-2-Roll (R2R) Metrology for NanoManufacturing

G. Gallatin, J.A. Liddle & J. Watkins (CHM-UMass. Amherst)

## Objective

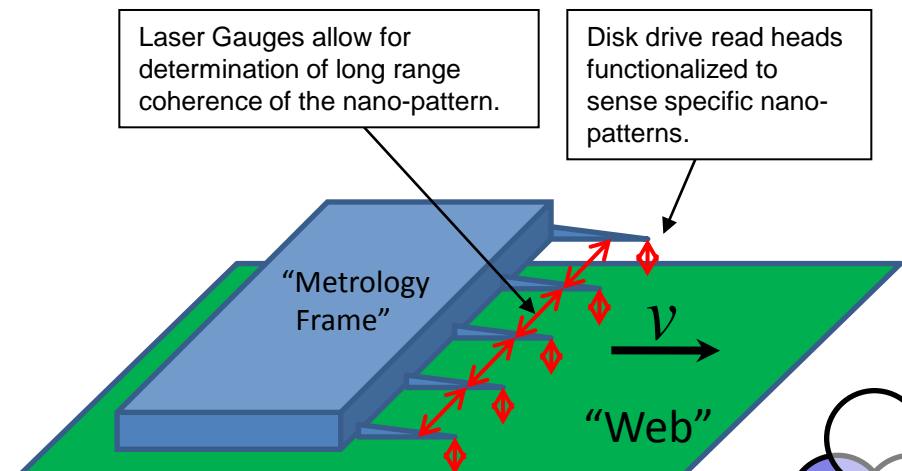
- Develop “good, fast, cheap” metrology solutions for real time measurement of short and long range nano-pattern fidelity.
- R2R goal is to produce coherent nano-scale patterns on ~1 meter wide substrates moving at ~1m/s
- ➔ Need nanoscale accuracy and precision at GHz rates over meter length scales.
- ➔ Needs to be cost effective

## Results and Impact

- For R2R to become a cost effective revenue generating nanomanufacturing technology it requires metrology that is:
  - Cheap
  - Accurate
  - Real-time
  - Online

## Method

- Metrology solution must be “keyed” to the desired nano-pattern
- Cheap → Use off-the-shelf technology
- Hard disk flying height sensor technology
- Laser interferometry for long range coherence
- Near field metrology for short range coherence.



# Measurement Needs

Two classes of measurements:

- Detailed, extensive
  - Develop understanding of basic processes
    - E.g. *In situ* observations of CNT growth for process window optimization
- On-line, fast
  - Enable process control during manufacture
    - E.g. Nanoscale structured-mask plasmonic devices for massively parallel interrogation of photomasks
- We're pretty good at the first, but the second need work!



# Summary

- High-throughput, top-down techniques exist
  - Need to match volumes and price points
- Bottom-up techniques are emerging
  - Need new control methods
  - Need to develop more modular approaches
- Measurements of basic phenomena available
- Measurements for process control lacking

